



Features

- RoHS compliant*
- Leadless
- High speed



This series is currently available but not recommended for new designs.

Switching Chip Diode Series - 0603/1005

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers small-signal high-speed Switching Diodes for switching digital signal applications, in compact chip package 0603 and 1005 size format, which offer PCB real estate savings and are considerably smaller than competitive parts. The Switching Diodes offer a forward current of 100 mA or 150 mA, a reverse voltage of 80 V or 75 V and also have a low leakage reverse current option. The diodes are RoHS compliant with Cu/Ni/Au plated terminations and are compatible with lead-free manufacturing processes, conforming to many industry and government regulations on lead-free components.

Bourns® Chip Diodes conform to JEDEC standards, are easy to handle on standard pick and place equipment and their flat configuration minimizes roll away.

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CDxxxx-S0180	CD1005-S01575	CDxxxx-S0180R	Unit
Forward Voltage (Max.)	V _F	1.00 (I _f = 100 mA)	1.00 (I _f = 50 mA)	1.00 (I _f = 100 mA)	V
Capacitance Between Terminals (Max.)	C _T	4 (f = 100 MHz, V _r = 1 V DC)			pF
Reverse Recovery Time (Max.)	t _{rr}	4 (V _r = 6 V, I _f = 10 mA, R _L = 50 ohms)			nS
Reverse Current (Max.)	I _R	0.1 (V _r = 80 V)	2.5 (V _r = 75 V)	0.05 (V _r = 75 V)	μA

Absolute Ratings (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CDxxxx-S0180	CD1005-S01575	CDxxxx-S0180R	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	90	100	90	V
Reverse Voltage	V _R	80	75	80	V
Average Forward Current	I _o	100	150	100	mA
Forward Current, Surge Peak	I _{surge}	1**	4***	1**	A
Power Dissipation CD0603 CD1005	P _D	150 300			mW
Storage Temperature	T _{STG}	-40 to +125			°C
Junction Temperature	T _J	-40 to +125			°C

** Condition: 8.3 ms single half sine-wave superimposed on rate load (JEDEC method).

*** Condition: 1.0 μs single half sine-wave superimposed on rate load (JEDEC method).

How to Order

	CD 0603 - S 01 80 R
Common Code _____	_____
Chip Diode	_____
Package _____	_____
• 0603	_____
• 1005	_____
Model _____	_____
S = High-Speed Switching	_____
Average Forward Current (I _o) Code _____	_____
01 = 100 mA	_____
015 = 150 mA	_____
(Code x 1000 mA = Average Forward Current)	_____
Reverse Voltage (V _R) Code _____	_____
80 = 80 V	_____
75 = 75 V	_____
Reverse Current Suffix _____	_____
R = Low Leakage I _R (CDxxxx-S0180R)	_____

*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

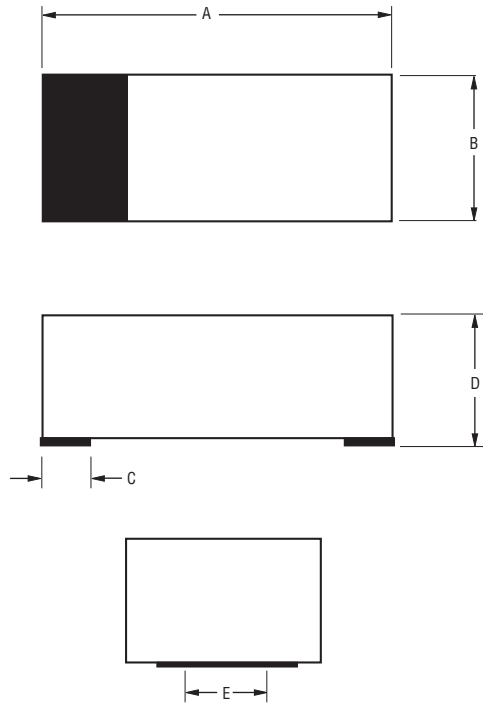
Applications

- Cellular phones
- PDAs
- Desktop PCs and notebooks
- Digital cameras
- MP3 players

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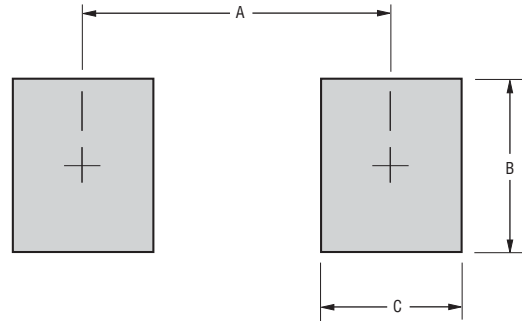
Product Dimensions



Dimension	0603	1005
A	$\frac{1.60 - 1.80}{(0.063 - 0.071)}$	$\frac{2.40 - 2.60}{(0.095 - 0.102)}$
B	$\frac{0.80 - 1.00}{(0.031 - 0.039)}$	$\frac{1.10 - 1.30}{(0.043 - 0.051)}$
C	$\frac{0.45}{(0.018)}$ Typ.	$\frac{0.50}{(0.020)}$ Typ.
D	$\frac{0.70 - 0.85}{(0.027 - 0.033)}$	$\frac{0.70 - 0.90}{(0.027 - 0.035)}$
E	$\frac{0.70}{(0.028)}$ Typ.	$\frac{1.00}{(0.039)}$ Typ.

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

Recommended Pad Layout



Dimension	0603	1005
A (Max.)	$\frac{1.25}{(0.049)}$	$\frac{2.00}{(0.079)}$
B (Min.)	$\frac{1.00}{(0.039)}$	$\frac{1.3}{(0.051)}$
C (Min.)	$\frac{0.6}{(0.024)}$	$\frac{0.7}{(0.028)}$

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

Physical Specifications

Case 0603(1608) / 1005(2512) Molded plastic
 Terminals Solder plated, solderable per MIL-STD-750,
 Method 2026
 Polarity..... Indicated by cathode band
 Mounting Position Any

Typical Part Marking

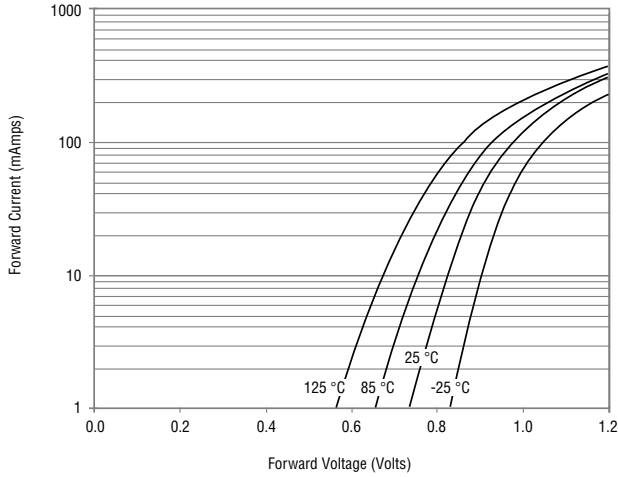
CDxxx-S0180..... S1
 CD1005-S01575..... S3
 CDxxx-S0180R..... S2

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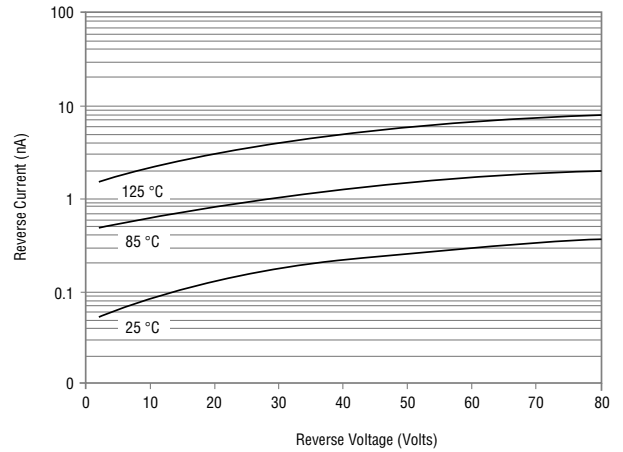
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Rating & Characteristic Curves: CDxxxx-S0180

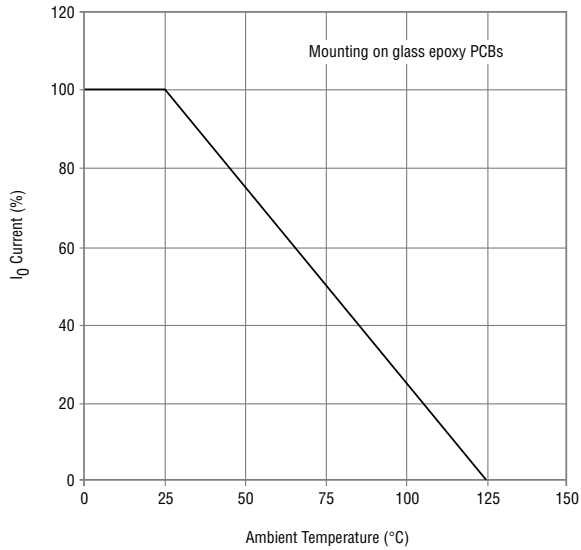
Forward Characteristics



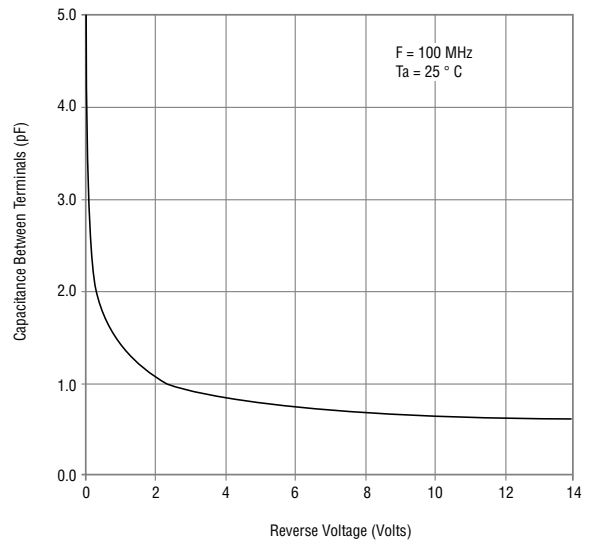
Reverse Characteristics



Derating Curve



Capacitance Between Terminals



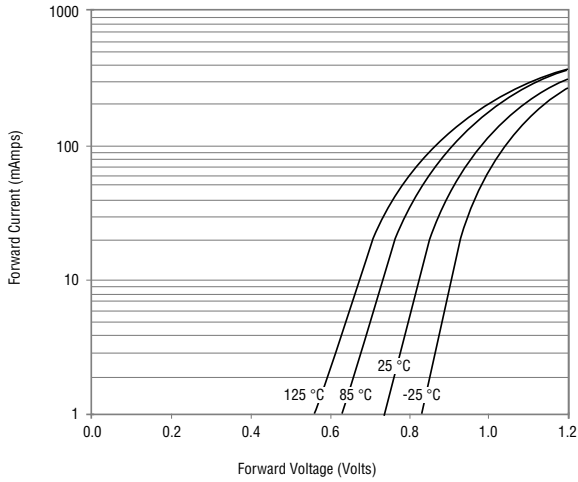
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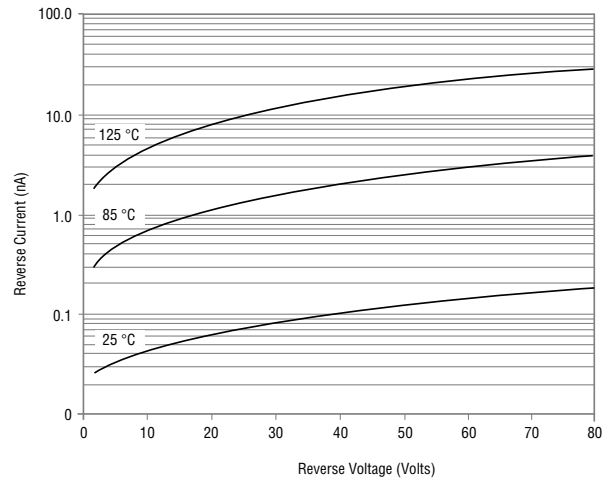
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Rating & Characteristic Curves: CD1005-S01575

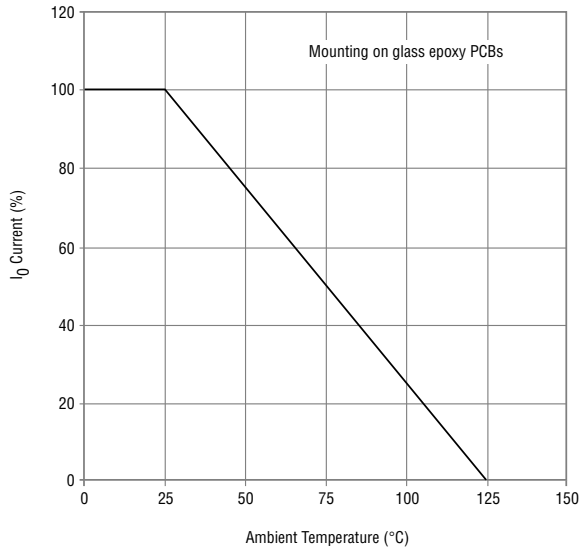
Forward Characteristics



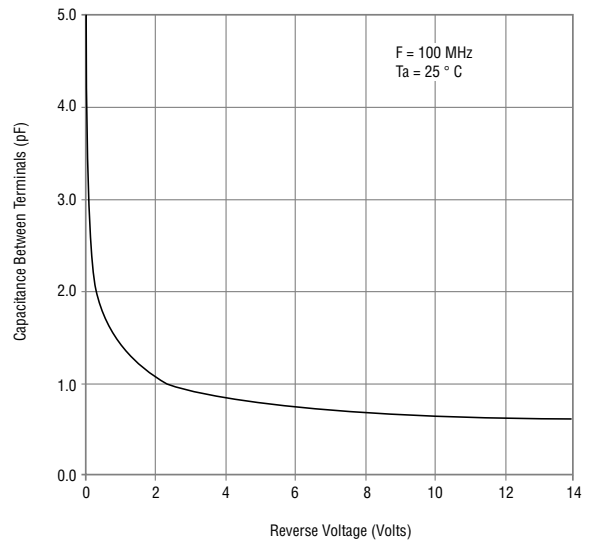
Reverse Characteristics



Derating Curve



Capacitance Between Terminals



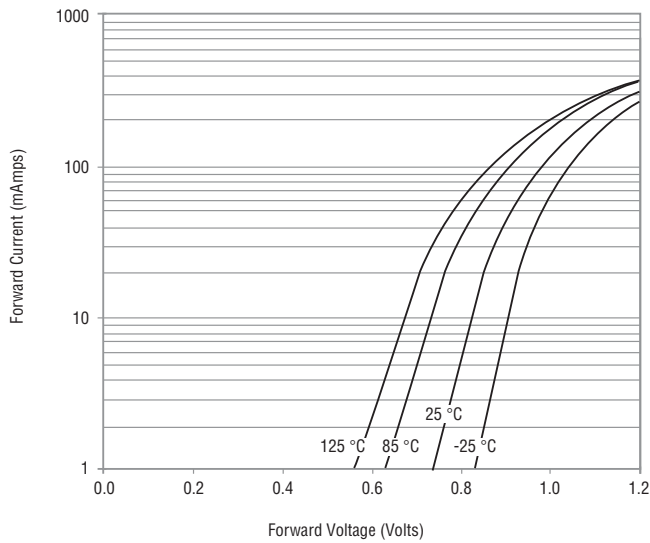
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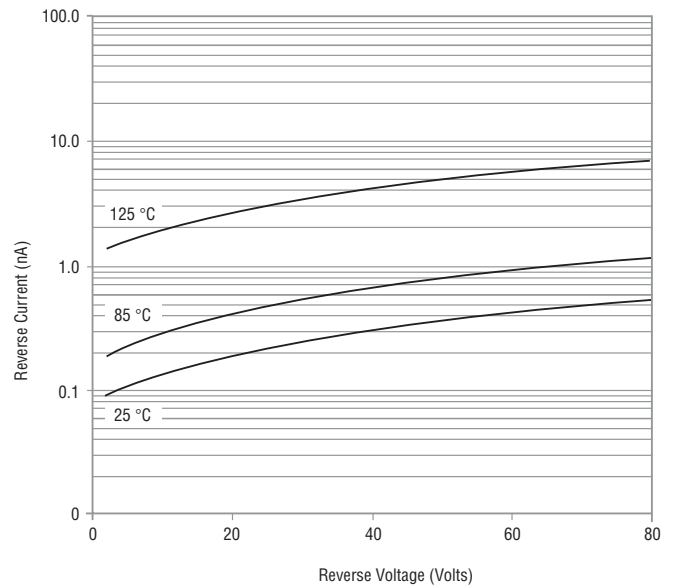
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Rating & Characteristic Curves: CDxxxx-S0180R

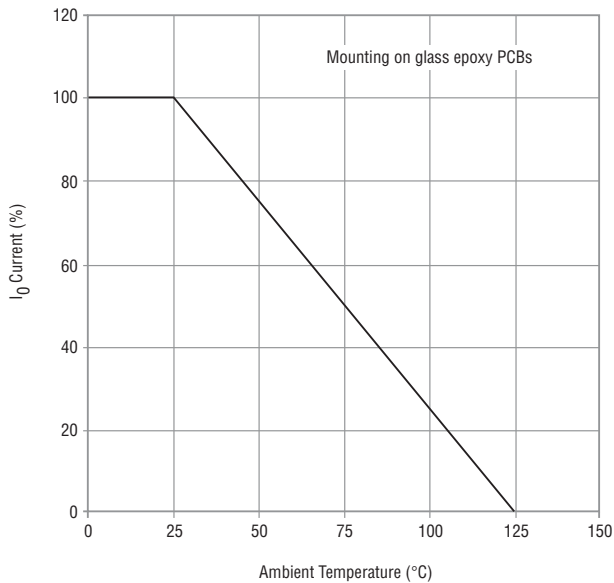
Forward Characteristics



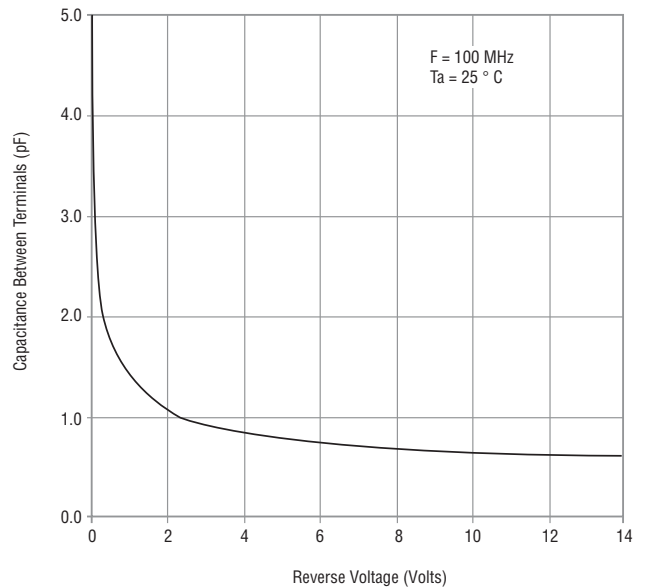
Reverse Characteristics



Derating Curve



Capacitance Between Terminals



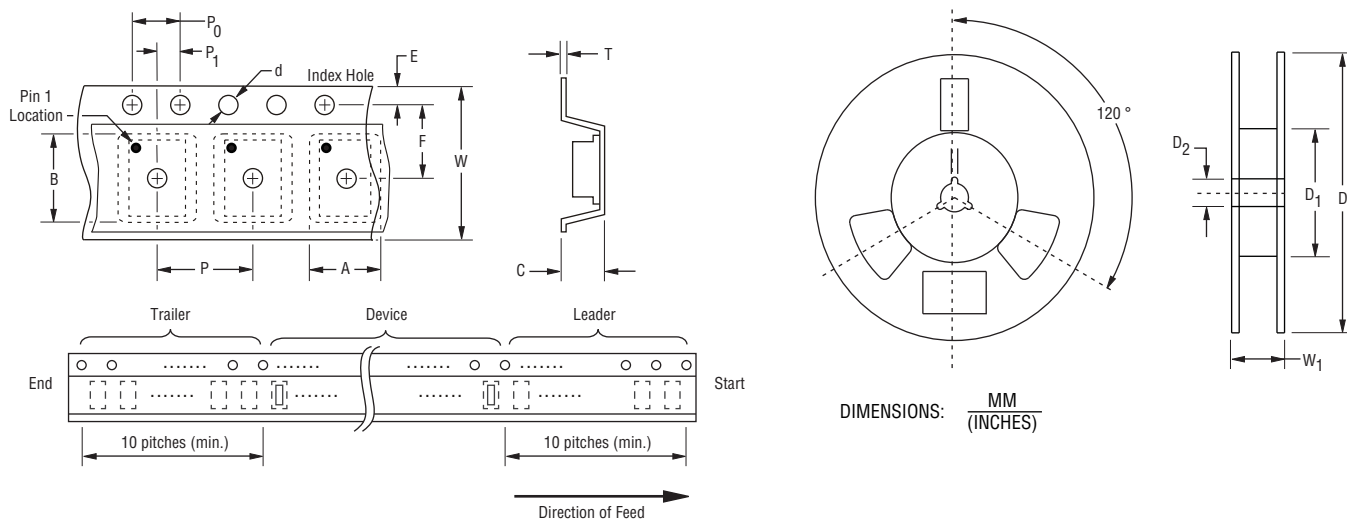
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Packaging Information

The product is packaged in tape and reel format per EIA-481 standard.



Item	Symbol	0603	1005
Carrier Width	A	$\frac{1.00 \pm 0.10}{(0.039 \pm 0.004)}$	$\frac{1.55 \pm 0.10}{(0.061 \pm 0.004)}$
Carrier Length	B	$\frac{1.85 \pm 0.10}{(0.073 \pm 0.004)}$	$\frac{2.65 \pm 0.10}{(0.104 \pm 0.004)}$
Carrier Depth	C	$\frac{1.00 \pm 0.10}{(0.039 \pm 0.004)}$	$\frac{1.05 \pm 0.10}{(0.041 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$	$\frac{1.55 \pm 0.10}{(0.061 \pm 0.004)}$
Reel Outside Diameter	D	$\frac{178}{(7.008)}$	$\frac{178}{(7.008)}$
Reel Inner Diameter	D ₁	$\frac{60.0}{(2.362)}$ MIN.	$\frac{60.0}{(2.362)}$ MIN.
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 \pm 0.002)}$	$\frac{3.50 \pm 0.05}{(0.138 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Sprocket Hole Pitch	P ₀	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.05}{(0.008 \pm 0.002)}$	$\frac{0.25 \pm 0.05}{(0.010 \pm 0.002)}$
Tape Width	W	$\frac{8.00 \pm 0.20}{(0.315 \pm 0.008)}$	$\frac{8.00 \pm 0.20}{(0.315 \pm 0.008)}$
Reel Width	W ₁	$\frac{13.5}{(0.531)}$ MAX.	$\frac{13.5}{(0.531)}$ MAX.
Quantity per Reel	--	4,000	4,000

REV. 12/15

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